

ON Semiconductor®

FQD12P10TM-F085

100V P-Channel MOSFET

General Description

These P-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, planar stripe, DMOS technology.

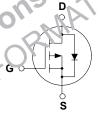
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as audio amplifier, high efficiency switching DC/DC converters, and DC motor control.

Features

- -9.4A, -100V, $R_{DS(on)} = 0.29\Omega$ @ $V_{GS} = -10 \text{ V}$
- Low gate charge (typical 21 nC)
- Low Crss (typical 65 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capabil.
- Qualified to AEC (
- RoHS Compant



D-PAI



Absolute Max num Patings To = 20°C unless of the presented

Symbol	Parameter	71. 60	Ratings	Units
V _{DS}	ain purce Voltage		-100	V
	Ore: Surren* - Continuous (T₁) = 25°	C)	-9.4	А
	- Continuous (T _C = 100°C)		-6.0	А
I _{DM}	Drain Current Pulsed	(Note 1)	-37.6	А
100	Gate Source /citage		± 30	V
-AS	Single Pulsed Avalanche Energy	(Note 2)	370	mJ
ΔR	Avalanci.e Curren	(Note 1)	-9.4	Α
Ear	Repetitive Avalariche Energy	(Note 1)	5.0	mJ
dv/dt	Peak Dic je Recovery dv/dt	(Note 3)	-6.0	V/ns
P _D	Power Dissipation (T _A = 25°C) *		2.5	W
_	Power Dissipation (T _C = 25°C)		50	W
	- Derate above 25°C		0.4	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes,		300	°C
	1/8" from case for 5 seconds		300	

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		2.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-100			V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I_D = -250 μ A, Referenced to 25°C		-0.1		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -100 V, V _{GS} = 0 V			-1	μΑ
		V _{DS} = -80 V, T _C = 125°C			-10	μΑ
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$			-4	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -4.7 A		0.24	0.29	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -40 V, I _D = -4.7 A Note 4)	 /	ა.3		S
Dynami	ic Characteristics			2 1		
C _{iss}	Input Capacitance	V _{DS} = 22 V _G = 0		620	003	pF
C _{oss}	Output Capacitance	f= JMHz		220	≥90	P.F
C _{rss}	Reverse Transfer Capacitance			C45	25	ρF
Switchi	ng Characteristics	105	0/	10	<i>b</i> ,	
t _{d(on)}	Turn-On Delay Time	50 % 4 5 4		15	40	ns
t _r	Turn-On Rise Time	$_{0} = -50 \text{ V} \cdot _{0} = -11.5 \text{ A}$ $R_{G} = 2.5 \text{ A}$		160	330	ns
t _{d(off)}	Turn-Off Delay Time			35	80	ns
t _f	Turn-Off F , Time	(Note 4, 5)		60	130	ns
Q _g	Total Gat Charge	$V_{DS} = -8.7 \text{ V}, i_D = -11.5 \text{ A},$		21	27	nC
Q _{gs}	ale Soul Char	V _{G.S} = -10 V		4.6		nC
Q_{gd}	² 7 Charge	(Note 4, 5)		11.5		nC
_ 1	70.0					•
ь. ⁱ n-	Ture Diode Characteristics ar					
l _S	naximum Continuous Drair -Source Dis	od: Forward Current			-9.4	Α
SM	Maximum Pulsed Drain-Source Diodo F				-37.6	Α
SD SD	Lrain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -9.4 \text{ A}$			-4.0	V
t _{rr}	Reverse Racovery Tin.c	$V_{GS} = 0 \text{ V}, I_{S} = -11.5 \text{ A},$		110		ns
Q _{ri}		$dI_{-}/dt = 100 \Delta/\mu s \qquad (Note 4)$				

- Notes: 1. Repetitive Rating : Pulse Vn.Ch limited by maximum junction temperature 2. L = 6.3mH, I_{AS} = -9.4A, V_{LD} = -25V, R_{G} = 25 Ω , Starting T_{J} = 25°C 3. I_{SD} ≤ -11.5A, di/dt ≤ 300A/µs, V_{DD} ≤ BV $_{DSS}$, Starting T_{J} = 25°C 4. Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2% 5. Essentially independent of operating temperature

Typical Characteristics

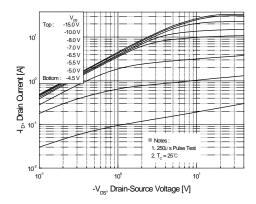
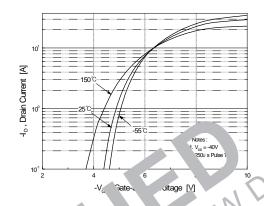


Figure 1. On-Region Characteristics



fer unaracteristics ?. Trai

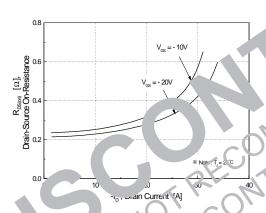


Fig... ა. On-Resistance Variation Drain Current and Gote Voltage

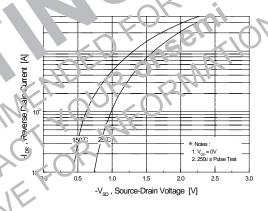


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

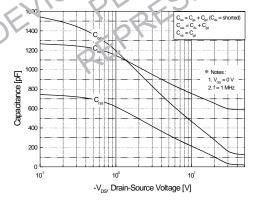


Figure 5. Capacitance Characteristics

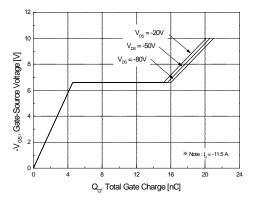


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

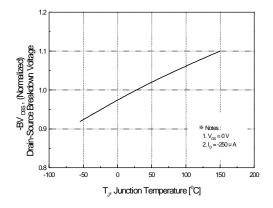
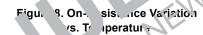
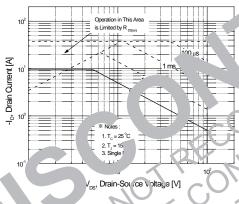
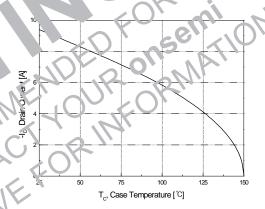


Figure 7. Breakdown Voltage Variation vs. Temperature







. vure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

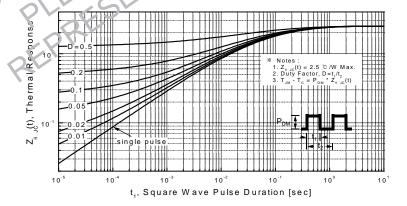
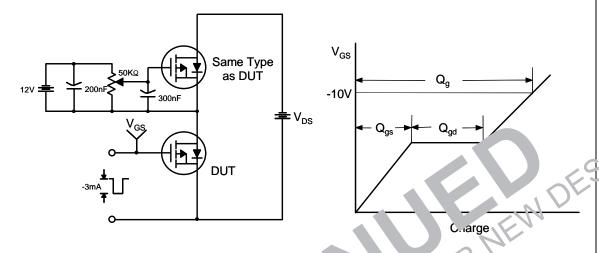
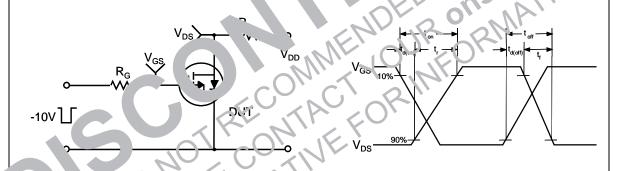


Figure 11. Transient Thermal Response Curve

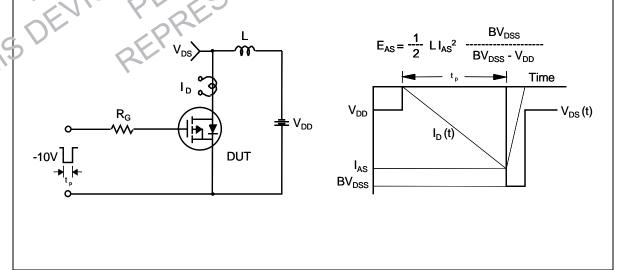
Gate Charge Test Circuit & Waveform

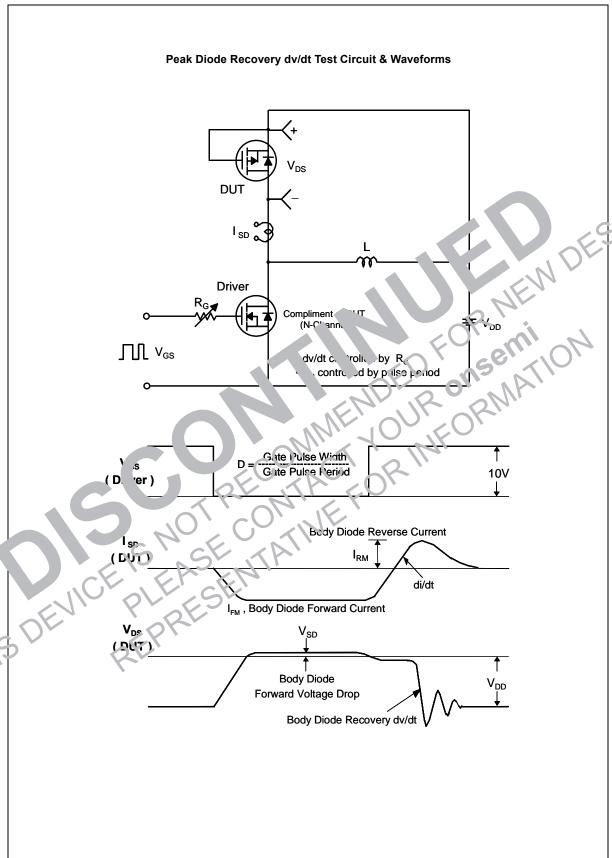


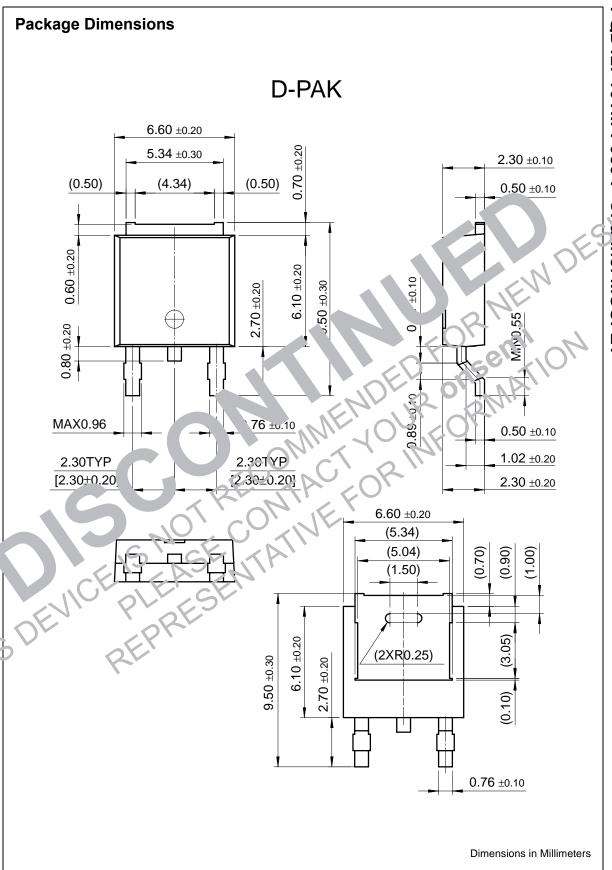
Resistive Switching 7 1 C. Wave.orms uit



Inclamped inductive Switching Test Circuit & Waveforms









ON Semiconductor and III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns me rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages.

Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada

Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative